

Layer	Stack up	Description	Finish Thickness	Isolation Distance	εr	Impedance ID	N1
		Liquid Photolmageable Mask			4.0000		
1		Copper Foil	0.0370			1	
		PCL370 HR 1080	0.0800	0.0769	4.2000		
		PCL370 HR 1080	0.0800	0.0769	4.2000		
2		FR4 Core	0.0180				
		FR4 Core	0.4100	0.4100	4.3000		
3		FR4 Core	0.0180			2	
		PCL370 HR 7628	0.1850	0.1774	4.2000		
		PCL370 HR 7628	0.1850	0.1774	4.2000		
4		FR4 Core	0.0180				
		FR4 Core	0.4100	0.4100	4.3000		
5		FR4 Core	0.0180			3	
		PCL370 HR 1080	0.0800	0.0760	4.2000		
		PCL370 HR 1080	0.0800	0.0760	4.2000		
6		Copper Foil	0.0370			4	
		Liquid Photolmageable Mask			4.0000		

1.6263

Impedance ID	Structure Name	Impedance Signal Layer	Broadside 2nd Layer	Ref. Plane 1 in Layer	Ref. Plane 2 in Layer	Lower Trace Width	Trace Separation	Lower Ground Strip Width	Trace Offset	Ground Strip Separation	Calculated Impedance	Target Impedance	Tol (+/- %)
1	Coated Microstrip 1B	1	0	2	0	0.2593	0.0000	0.0000	0.0000	0.0000	50.0300	50.0000	10.0000
2	Offset Stripline 1B1A	3	0	2	4	0.3403	0.0000	0.0000	0.0000	0.0000	49.9800	50.0000	10.0000
3	Offset Stripline 1B1A	5	0	4	6	0.1869	0.0000	0.0000	0.0000	0.0000	49.9500	50.0000	10.0000
4	Coated Microstrip 1B	6	0	5	0	0.2564	0.0000	0.0000	0.0000	0.0000	49.9700	50.0000	10.0000

Notes

StackName:	Version:	Revision:	Modification:	Date of Revision:	Editor	Page 1/1	
Date:	Associated Documents:						
Author:							
Department:							
Site:							